

Docket No. 295770US40X PCT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Akio SEKIMOTO, et al.

SERIAL NO: 10/594,244

GAU: 1795

FILED: September 25, 2006

EXAMINER:

FOR: PROCESS FOR FORMING A SOLDER MASK, APPARATUS THEREOF AND
PROCESS FOR FORMING ELECTRIC-CIRCUIT PATTERNED INTERNAL
DIELECTRIC LAYER

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- Submitted herewith is a Chinese Office Action for the Examiner's consideration.

RELATED CASES


- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.

CERTIFICATION

- ☐ Each item of information not previously filed or cited by the Examiner in this application was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

Respectfully submitted,

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